SMART SCHOOLS WIRING PROJECT

RUS CARBON

THOMAS LYNCH

Smart Schools

The Smart Schools Bond Act, approved by New York State voters in 2014, authorized the issuance of \$2 billion of general obligation bonds to finance improved educational technology and infrastructure to improve learning and opportunity for students throughout the State.

Seaford UFSD has been awarded \$1,103,841 through the *Smart Schools Bond Act* to improve our computer network infrastructure.



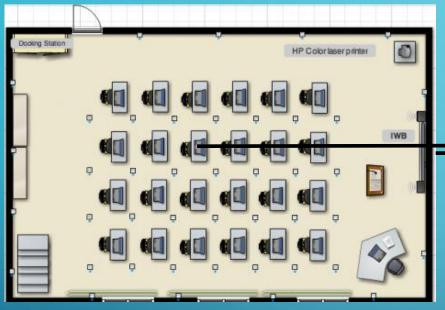


The Smart Schools

Bond Act funding
will be used to
update the network
cabling in all four
schools.

An evaluation of our current network was set up by Mr. Kaden and on January 2nd and 3rd, Mr. Carbon and Mr. Lynch conducted a walk-through with a team from NCD Communications and BOCES Department of Curriculum, Instruction and Technology.

The purpose of this walk-through was to assess the current status of our network cabling and how best to utilize the funds from the *Smart Schools Bond Act* to update our infrastructure.



For wireless access point (AP)

For network port



Our current network was designed prior to our PDL Initiative







Network Drops

Access Point

Epson Projector

Our current network is mostly Cat5 cabling, which was designed for technology use 20 years ago.

There are also sections of the network that consists of even older Cat3 and other sections with newer Cat 6.

The current standard is Catóa and this project would put our entire network on this current cabling standard.





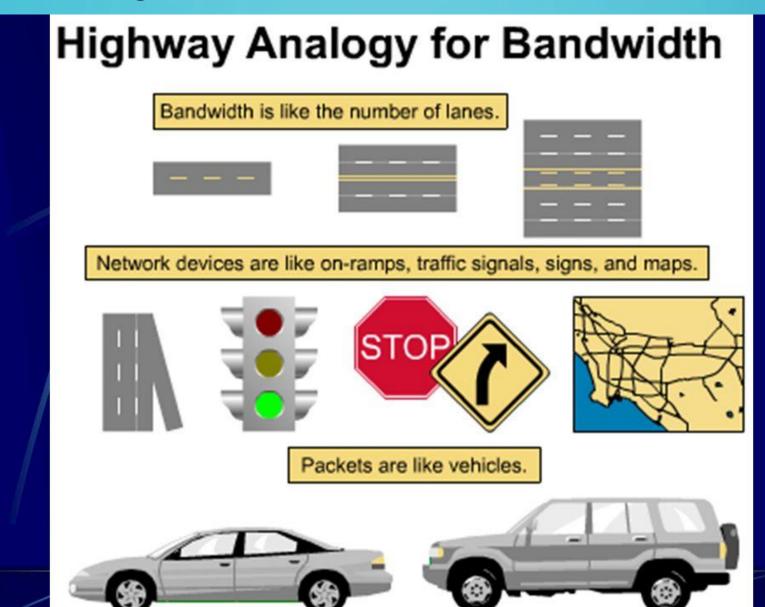
Existing wiring racks and switches

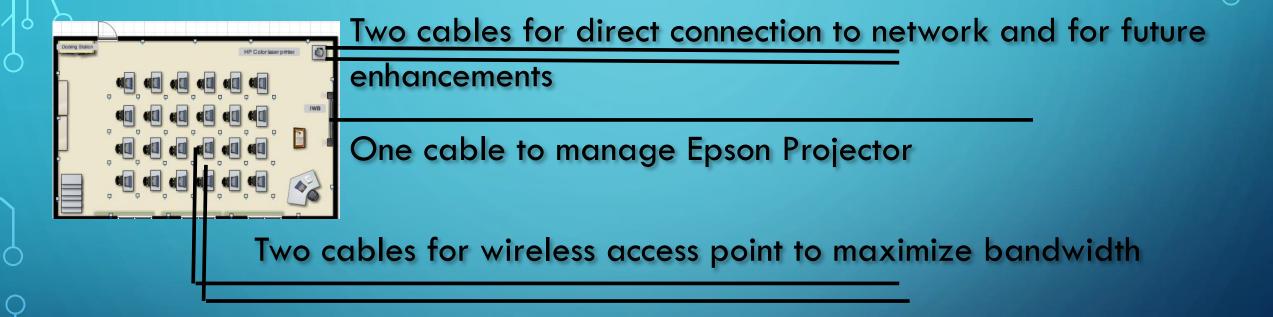
Improvements to the network with Smart Schools Bond Act funding

	Category 3	Category 5	Category 5e	Category 6	Category 6a
Cable Type	UTP	UTP	UTP	UTP or STP	STP
Max. Data Transmission Speed	10 Mbps	10/100/1000 Mbps	10/100/1000 Mbps	10/100/1000 Mbps	10,000 Mbps
Max. Bandwidth	16 MHz	100 MHz	100 MHz	250 MHz	500 MHz

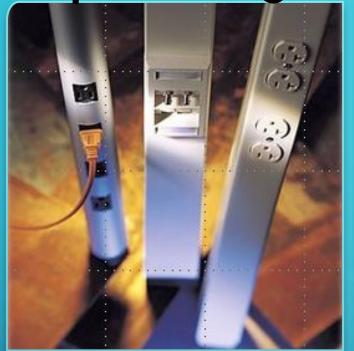
Most of existing network is on Cat5

Increase in bandwidth provides higher transmission speed and data sizes





All cabling will be with the current industry standard of Cat6a



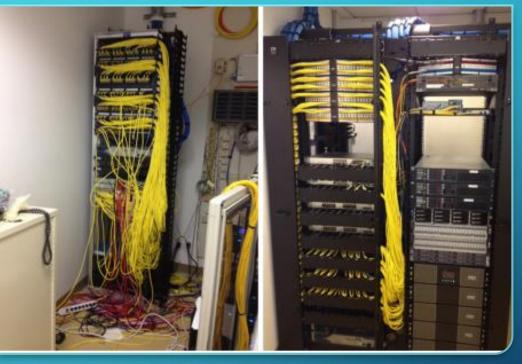




Cabling will be bundled and hung following industry standards

Exposed cabling will be run through conduit





All cabling will be color coded by function

Cabling at IDFs and MDFs will be bundled with labeled connections

Project Plan

The network cabling project has been planned in cooperation with our district architect, John A. Grillo

The network cabling project plans were sent to NYSED and we have been approved to begin this work.

After completing the walk-though with NCD, and consulting with other districts, our plan is to use NCD for this project.

Project Plan

Using BOCES with NCD has the following benefits:

- BOCES would coordinate work between NCD and Seaford Technology and Facilities Departments
- BOCES management fees are estimated to be aided at 65%
- NCD has expertise working in schools (most recently in Bellmore, Bellmore-Merrick, Hicksville, Merrick, Oyster Bay, Roslyn, Syosset)
- NCD incorporates best practices
- Materials such as cables and connectors will be industry standard
- Work will begin this summer

Project Expected Costs

- We expect to receive 65% aid on the BOCES Management Fee of \$75,000 which yields a district cost of \$26,250
- We are currently exploring our ability to include architectural fees into the Smart Schools Bond
- Nearly the entire project, projected to cost approximately a million dollars,
 will be funded through the Smart Schools Bond Act